$5 \times 7$ Dot Character $\times$ 16-Digit Display Controller/Driver with Character RAM

## GENERAL DESCRIPTION

The ML9208-xx is a dot matrix vacuum fluorescent display tube controller driver IC which displays characters, numerics and symbols.
Dot matrix vacuum fluorescent display tube drive signals are generated by serial data sent from a micro-controller. A display system is easily realized by internal ROM and RAM for character display.

## FEATURES

- Logic power supply and vacuum fluorescent display tube drive power supply ( $\mathrm{V}_{\mathrm{DD}}$ )
$: 3.3 \mathrm{~V} \pm 10 \%$ or $5.0 \mathrm{~V} \pm 10 \%$
- Fluorescent display tube drive power supply $\left(\mathrm{V}_{\mathrm{FL}}\right): \mathrm{V}_{\mathrm{DD}}-20 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}-42 \mathrm{~V}$
- VFD driver output current
(VFD driver output can be connected directly to the fluorescent display tube. No pull-down resistor is required.)
- Segment driver (SEG1 to SEG35) : $-6 \mathrm{~mA} \quad\left(\mathrm{~V}_{\mathrm{FL}}=\mathrm{V}_{\mathrm{DD}}-42 \mathrm{~V}\right)$
- Segment driver (AD1 and AD2) $:-15 \mathrm{~mA}\left(\mathrm{~V}_{\mathrm{FL}}=\mathrm{V}_{\mathrm{DD}}-42 \mathrm{~V}\right)$
- Grid driver (COM1 to COM16)
$:-30 \mathrm{~mA}\left(\mathrm{~V}_{\mathrm{FL}}=\mathrm{V}_{\mathrm{DD}}-42 \mathrm{~V}\right)$
- General output port output current
- Output driver (P1 and P2)
- Content of display
- CGROM $5 \times 7$ dots $: 248$ types (character data)
- CGRAM $5 \times 7$ dots $: 8$ types (character data)
- ADRAM 16 (display digit) $\times 2$ bits (symbol data)
- DCRAM 16 (display digit) $\times 8$ bits (register for character data display)
- General output port 2 bits (static operation)
- Display control function
- Display digit :9 to 16 digits
- Display duty (contrast adjustment) :8 stages
- All lights ON/OFFs
- 3 interfaces with microcontroller : DA, $\overline{\mathrm{CS}}, \overline{\mathrm{CP}}$ (4 interfaces when $\overline{\mathrm{RESET}}$ is added)
- 1-byte instruction execution (excluding data write to RAM)
- Built-in oscillation circuit (external R and C)
- Package options:

64-pin plastic QFP (QFP64-P-1414-0.80-BK) (ML9208-xxGA)
64-pin plastic SSOP (SSOP64-P-525-0.80-K) (ML9208-xxMB)

## BLOCK DIAGRAM



## PIN CONFIGURATION (TOP VIEW)



## 64-Pin Plastic QFP



64-Pin Plastic SSOP

## PIN DESCRIPTION

| Pin |  | Symbol | Type | Connects to | Description |
| :---: | :---: | :---: | :---: | :---: | :---: |
| QFP | SSOP |  |  |  |  |
| 1 to 31 , 61 to 64 | 5 to 39 | SEG1 to 35 | 0 | Fluorescent tube anode electrode | Fluorescent display tube anode electrode drive output. Directly connected to fluorescent display tube and a pull-down resistor is not necessary. $\mathrm{I}_{\mathrm{OH}}>-6 \mathrm{~mA}$ |
| 32 to 47 | 40 to 55 | COM1 to 16 | 0 | Fluorescent tube grid electrode | Fluorescent display tube grid electrode drive output. Directly connected to fluorescent display tube and a pull-down resistor is not necessary. $\mathrm{I}_{\mathrm{OH}}>-30 \mathrm{~mA}$ |
| 59, 60 | 3, 4 | AD1, AD2 | 0 | Fluorescent tube anode electrode | Fluorescent display tube anode electrode drive output. Directly connected to fluorescent display tube and a pull-down resistor is not necessary. $\mathrm{l}_{\mathrm{OH}}>-15 \mathrm{~mA}$ |
| 57, 58 | 1, 2 | P1, P2 | 0 | LED drive control pins | General port output. <br> Output of these pins in static operation, so these pins can drive the LED. |
| 56 | 64 | $V_{\text {DD }}$ | - | Power supply | $V_{D D}-G N D$ are power supplies for internal logic. <br> $V_{D D}-V_{F L}$ are power supplies for driving fluorescent tubes. Apply $\mathrm{V}_{F L}$ after $\mathrm{V}_{\mathrm{DD}}$ is applied. |
| 49 | 57 | GND |  |  |  |
| 48 | 56 | $V_{\text {FL }}$ |  |  |  |
| 55 | 63 | DA | 1 | Microcontroller | Serial data input (positive logic). Input from LSB. |
| 54 | 62 | $\overline{\mathrm{CP}}$ | 1 | Microcontroller | Shift clock input. <br> Serial data is shifted on the rising edge of $\overline{\mathrm{CP}}$. |
| 53 | 61 | $\overline{\mathrm{CS}}$ | 1 | Microcontroller | Chip select input. <br> Serial data transfer is disabled when $\overline{\mathrm{CS}}$ pin is " H " level. |
| 52 | 60 | $\overline{\text { RESET }}$ | 1 | Microcontroller or $\mathrm{C}_{2}, \mathrm{R}_{2}$ | Reset input. <br> "Low" initializes all the functions. <br> Initial status is as follows. <br> - Address of each RAM .... address " 00 " H <br> - Data of each RAM .......... Content is undefined <br> - Display digit ...................... 16 digits <br> - Contrast adjustment ....... 8/16 <br> - All lights ON or OFF ....... OFF mode <br> - All outputs $\qquad$ "Low" level <br> (Circuit when R and C are connected externally) See Application Circuit. |
| 50 | 58 | OSCO | 1 | $\mathrm{C}_{1}, \mathrm{R}_{1}$ | External RC pin for RC oscillation. <br> Connect R and C externally. The RC time constant depends on the $V_{D D}$ voltage used. Set the target oscillation frequency to 2 MHz . |
| 51 | 59 | OSC1 | 0 |  | (RC oscillation circuit) See Application Circuit. |

## ABSOLUTE MAXIMUM RATINGS

| Parameter | Symbol | Condition |  | Rating | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Supply Voltage (1) | $V_{D D}$ | - |  | -0.3 to 6.5 | V |
| Supply Voltage (2) | $\mathrm{V}_{\mathrm{FL}}$ | - |  | -45 to $\mathrm{V}_{\mathrm{DD}}+0.3$ | V |
| Input Voltage | $\mathrm{V}_{\text {IN }}$ | - |  | -0.3 to $\mathrm{V}_{\mathrm{DD}}+0.3$ | V |
| Power Dissipation | $\mathrm{P}_{\mathrm{D}}$ | $\mathrm{Ta} \geq 25^{\circ} \mathrm{C}$ | QFP | 541 | mW |
|  |  |  | SSOP | 590 |  |
| Storage Temperature | $\mathrm{T}_{\text {STG }}$ | - |  | -55 to 150 | ${ }^{\circ} \mathrm{C}$ |
| Output Current | $\mathrm{l}_{1}$ | COM1 to 16 |  | -40 to 0.0 | mA |
|  | $\mathrm{l}_{0}$ | AD1, AD2 |  | -20 to 0.0 | mA |
|  | $\mathrm{l}_{1}$ | SEG1 to 35 |  | -10 to 0.0 | mA |
|  | $\mathrm{l}_{04}$ | P1, P2 |  | -4.0 to 4.0 | mA |

## RECOMMENDED OPERATING CONDITIONS-1

When the power supply voltage is 5 V (typ.)

| Parameter | Symbol | Condition | Min. | Typ. | Max. | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Supply Voltage (1) | $\mathrm{V}_{\mathrm{DD}}$ | - | 4.5 | 5.0 | 5.5 | V |
| Supply Voltage (2) | $\mathrm{V}_{\mathrm{FL}}$ | - | -36.5 | - | -20 | V |
| High Level Input Voltage | $\mathrm{V}_{\mathrm{IH}}$ | All input pins excluding OSC0 pin | $0.7 \mathrm{~V}_{\mathrm{DD}}$ | - | - | V |
| Low Level Input Voltage | $\mathrm{V}_{\mathrm{IL}}$ | All input pins excluding OSCO pin | - | - | $0.3 \mathrm{~V}_{\mathrm{DD}}$ | V |
| $\overline{\mathrm{CP}}$ Frequency | - | - | - | 2.0 | MHz |  |
| Oscillation Frequency | $\mathrm{f}_{\mathrm{C}}$ | - | $\mathrm{R}_{1}=3.3 \mathrm{k} \Omega, \mathrm{C}_{1}=39 \mathrm{pF}$ | 1.5 | 2.0 | 2.5 |
| Frame Frequency | $\mathrm{f}_{\mathrm{FR}}$ | DIGIT $=1$ to $16, \mathrm{R}_{1}=3.3 \mathrm{k} \Omega, \mathrm{C}_{1}=39 \mathrm{pF}$ | 183 | 244 | 305 | Hz |
| Operating Temperature | $\mathrm{T}_{\mathrm{Op}}$ | - | -40 | - | 85 | ${ }^{\circ} \mathrm{C}$ |

## RECOMMENDED OPERATING CONDITIONS-2

When the power supply voltage is 3.3 V (typ.)

| Parameter | Symbol | Condition | Min. | Typ. | Max. | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Supply Voltage (1) | $\mathrm{V}_{\mathrm{DD}}$ | - | 3.0 | 3.3 | 3.6 | V |
| Supply Voltage (2) | $\mathrm{V}_{\mathrm{FL}}$ | - | -38.4 | - | -20 | V |
| High Level Input Voltage | $\mathrm{V}_{\mathrm{IH}}$ | All input pins excluding OSC0 pin | $0.8 \mathrm{~V}_{\mathrm{DD}}$ | - | - | V |
| Low Level Input Voltage | $\mathrm{V}_{\mathrm{IL}}$ | All input pins excluding OSC0 pin | - | - | $0.2 \mathrm{~V}_{\mathrm{DD}}$ | V |
| $\overline{\mathrm{CP}}$ Frequency | $\mathrm{f}_{\mathrm{C}}$ | - | - | - | 2.0 | MHz |
| Oscillation Frequency | $\mathrm{f}_{\mathrm{OSC}}$ | $\mathrm{R}_{1}=3.3 \mathrm{k} \Omega, \mathrm{C}_{1}=39 \mathrm{pF}$ | 1.5 | 2.0 | 2.5 | MHz |
| Frame Frequency | $\mathrm{f}_{\mathrm{FR}}$ | DIGIT $=1$ to $16, \mathrm{R}_{1}=3.3 \mathrm{k} \Omega, \mathrm{C}_{1}=39 \mathrm{pF}$ | 183 | 244 | 305 | Hz |
| Operating Temperature | $\mathrm{T}_{\mathrm{op}}$ | - | -40 | - | 85 | ${ }^{\circ} \mathrm{C}$ |

## ELECTRICAL CHARACTERISTICS

## DC Characteristics-1

| Parameter | Symbol | Applied pin |  | Condition | Min. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| High Level Input Voltage | $\mathrm{V}_{\mathrm{H}}$ | $\overline{\overline{\mathrm{CS}}, \overline{\mathrm{CP}}, \mathrm{DA},}$ |  | - | 0.7 V D | - | V |
| Low Level Input Voltage | $\mathrm{V}_{\text {IL }}$ | $\overline{\overline{\mathrm{CS}}, \overline{\mathrm{CP}}, \mathrm{DA},}$ |  | - | - | $0.3 \mathrm{~V}_{\mathrm{DD}}$ | V |
| High Level Input Current | $\mathrm{I}_{\mathrm{H}}$ | $\overline{\overline{\mathrm{CS}}, \overline{\mathrm{CP}}, \mathrm{DA},}$ |  | $\mathrm{V}_{1 H}=\mathrm{V}_{\mathrm{DD}}$ | -1.0 | 1.0 | $\mu \mathrm{A}$ |
| Low Level Input Current |  | $\overline{\overline{\mathrm{CS}}, \overline{\mathrm{CP}}, \mathrm{DA},}$ |  | $\mathrm{V}_{\mathrm{IL}}=0.0 \mathrm{~V}$ | -1.0 | 1.0 | $\mu \mathrm{A}$ |
| High Level Output Voltage | $\mathrm{V}_{\mathrm{OH} 1}$ | COM1 to 16 |  | $\mathrm{l}_{\mathrm{OH} 1}=-30 \mathrm{~mA}$ | $\mathrm{V}_{\mathrm{DD}}-1.5$ | - | V |
|  | $\mathrm{V}_{\mathrm{OH} 2}$ | AD1, AD2 |  | $\mathrm{l}_{\mathrm{H} 2}=-15 \mathrm{~mA}$ | $V_{D D}-1.5$ | - | V |
|  | $\mathrm{V}_{\text {OH3 }}$ | SEG1 to 35 |  | $\mathrm{l}_{\mathrm{OH} 3}=-6 \mathrm{~mA}$ | $V_{D D}-1.5$ | - | V |
|  | $\mathrm{V}_{\mathrm{OH} 4}$ | P1, P2 |  | $\mathrm{l}_{\mathrm{OH} 4}=-2 \mathrm{~mA}$ | $V_{D D}-1.0$ | - | V |
| Low Level Output Voltage | VoL1 | COM1 to 16 AD1, AD2 SEG1 to 35 |  | - | - | $\mathrm{V}_{\mathrm{FL}}+1.0$ | V |
|  | VoL2 | P1, P2 |  | $\mathrm{l}_{\mathrm{LL} 1}=2 \mathrm{~mA}$ | - | 1.0 | V |
| Current Consumption | $\mathrm{I}_{\mathrm{DD} 1}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\begin{aligned} & \text { fosc }= \\ & 2 \mathrm{MHz}, \\ & \text { no load } \end{aligned}$ | $\begin{aligned} & \text { Duty }=15 / 16 \\ & \text { Digit }=1 \text { to } 16 \end{aligned}$ <br> All output lights ON | - | 4 | mA |
|  | $\mathrm{I}_{\mathrm{DD} 2}$ |  |  | $\begin{aligned} & \text { Duty }=8 / 16 \\ & \text { Digit }=1 \text { to } 9 \end{aligned}$ <br> All output lights OFF | - | 3 | mA |

DC Characteristics-2

| Parameter | Symbol | Applied pin |  | Condition | Min. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| High Level Input Voltage | $\mathrm{V}_{1}$ | $\overline{\mathrm{CS}}, \overline{\mathrm{CP}}$, <br> DA, $\overline{R E S E T}$ |  | - | 0.8 V DD | - | V |
| Low Level Input Voltage | VIL | $\begin{aligned} & \overline{\overline{C S}}, \overline{\overline{C P}}, \\ & \mathrm{DA}, \overline{\mathrm{RESET}} \end{aligned}$ |  | - | - | 0.2 V ${ }_{\text {D }}$ | V |
| High Level Input Current | $\mathrm{IIH}^{\text {H}}$ | $\begin{aligned} & \overline{\mathrm{CS}}, \overline{\mathrm{CP}}, \\ & \mathrm{DA}, \overline{\mathrm{RESET}} \end{aligned}$ |  | $\mathrm{V}_{\mathrm{IH}}=\mathrm{V}_{\mathrm{DD}}$ | -1.0 | 1.0 | $\mu \mathrm{A}$ |
| Low Level Input Current | 11. | $\begin{array}{\|l\|} \hline \overline{\mathrm{CS}}, \overline{\mathrm{CP}}, \\ \mathrm{DA}, \overline{\mathrm{RESET}} \\ \hline \end{array}$ |  | $\mathrm{V}_{\mathrm{IL}}=0.0 \mathrm{~V}$ | -1.0 | 1.0 | $\mu \mathrm{A}$ |
| High Level Output Voltage | $\mathrm{V}_{\mathrm{OH} 1}$ | COM1 to 16 |  | $\mathrm{lOH}_{1}=-30 \mathrm{~mA}$ | $V_{D D}-1.5$ | - | V |
|  | $\mathrm{V}_{\mathrm{OH} 2}$ | AD1, AD2 |  | $\mathrm{l}_{\mathrm{OH} 2}=-15 \mathrm{~mA}$ | $V_{D D}-1.5$ | - | V |
|  | $\mathrm{V}_{\text {онз }}$ | SEG1 to 35 |  | $\mathrm{I}_{\text {OH3 }}=-6 \mathrm{~mA}$ | $\mathrm{V}_{\mathrm{DD}}-1.5$ | - | V |
|  | $\mathrm{V}_{\text {OH4 }}$ | P1, P2 |  | $\mathrm{l}_{\mathrm{OH} 4}=-1 \mathrm{~mA}$ | $V_{D D}-1.0$ | - | V |
| Low Level Output Voltage | $\mathrm{V}_{\text {OL1 }}$ | COM1 to 16 <br> AD1, AD2 <br> SEG1 to 35 |  | - | - | $\mathrm{V}_{\mathrm{FL}}+1.0$ | V |
|  | VoL2 | P1, P2 |  | $\mathrm{l}_{\mathrm{OL} 1}=1 \mathrm{~mA}$ | - | 1.0 | V |
| Current Consumption | $\mathrm{I}_{\mathrm{DD} 1}$ | $V_{\text {DD }}$ | $\begin{aligned} & \text { Fosc = } \\ & 2 \mathrm{MHz}, \\ & \text { no load } \end{aligned}$ | $\begin{aligned} & \text { Duty }=15 / 16 \\ & \text { Digit }=1 \text { to } 16 \end{aligned}$ <br> All output lights ON | - | 3 | mA |
|  | $\mathrm{I}_{\mathrm{DD} 2}$ |  |  | $\begin{aligned} & \text { Duty }=8 / 16 \\ & \text { Digit }=1 \text { to } 9 \end{aligned}$ <br> All output lights OFF | - | 2 | mA |

## AC Characteristics-1

$\left(\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\mathrm{FL}}=\mathrm{V}_{\mathrm{DD}}-42 \mathrm{~V}, \mathrm{Ta}=-40\right.$ to $+85^{\circ} \mathrm{C}$, unless otherwise specified)

| Parameter | Symbol | Condition |  | Min. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\overline{\mathrm{CP}}$ Frequency | $\mathrm{f}_{\mathrm{C}}$ | - |  | - | 2.0 | MHz |
| $\overline{\mathrm{CP}}$ Pulse Width | $\mathrm{t}_{\mathrm{cw}}$ | - |  | 250 | - | ns |
| DA Setup Time | tDs | - |  | 250 | - | ns |
| DA Hold Time | tDh | - |  | 250 | - | ns |
| $\overline{\text { CS S Setup Time }}$ | tcss | - |  | 250 | - | ns |
| $\overline{\text { CS Hold Time }}$ | tcsh | $\mathrm{R}_{1}=3.3 \mathrm{k} \Omega, \mathrm{C}_{1}=47 \mathrm{pF}$ |  | 16 | - | $\mu \mathrm{S}$ |
| $\overline{\text { CS Wait Time }}$ | tcsw | - |  | 250 | - | ns |
| Data Processing Time | t Doff | $\mathrm{R}_{1}=3.3 \mathrm{k} \Omega, \mathrm{C}_{1}=47 \mathrm{pF}$ |  | 8 | - | $\mu \mathrm{S}$ |
| RESET Pulse Width | twres | When $\overline{\text { RESET }}$ signal is input from microcontroller etc. externally |  | 250 | - | ns |
| $\overline{\text { RESET Time }}$ | $t_{\text {RSON }}$ | When $\overline{\text { RESET }}$ signal is input from microcontroller etc. externally |  | 250 | - | ns |
|  |  | $\mathrm{R}_{2}=1.0 \mathrm{k} \Omega, \mathrm{C}_{2}=0.1 \mu \mathrm{~F}$ |  | - | 200 | $\mu \mathrm{s}$ |
| DA Wait Time | $\mathrm{t}_{\text {RSOFF }}$ | - |  | 250 | - | ns |
| All Output Slew Rate | $\mathrm{t}_{\mathrm{R}}$ | $\mathrm{C}_{\mathrm{l}}=100 \mathrm{pF}$ | $\mathrm{t}_{\mathrm{R}}=20$ to $80 \%$ | - | 2.0 | $\mu \mathrm{S}$ |
|  | $\mathrm{t}_{\mathrm{F}}$ |  | $\mathrm{t}_{\mathrm{F}}=80$ to $20 \%$ | - | 2.0 | $\mu \mathrm{S}$ |
| $V_{\text {DD }}$ Rise Time | tprz | When mounted in the unit |  | - | 100 | $\mu \mathrm{S}$ |
| $V_{\text {DD }}$ Off Time | $\mathrm{t}_{\text {POF }}$ | When mounted in the unit, $\mathrm{V}_{\mathrm{DD}}=0.0 \mathrm{~V}$ |  | 5.0 | - | ms |

## AC Characteristics-2

$\left(\mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\mathrm{FL}}=\mathrm{V}_{\mathrm{DD}}-42 \mathrm{~V}, \mathrm{Ta}=-40\right.$ to $+85^{\circ} \mathrm{C}$, unless otherwise specified)

| Parameter | Symbol | Condition |  | Min. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\overline{\mathrm{CP}}$ Frequency | $\mathrm{f}_{\mathrm{C}}$ | - |  | - | 2.0 | MHz |
| $\overline{\mathrm{CP}}$ Pulse Width | tcw | - |  | 250 | - | ns |
| DA Setup Time | tos | - |  | 250 | - | ns |
| DA Hold Time | $t_{\text {DH }}$ | - |  | 250 | - | ns |
| $\overline{\mathrm{CS}}$ Setup Time | tcss | - |  | 250 | - | ns |
| $\overline{\mathrm{CS}}$ Hold Time | tcsh | $\mathrm{R}_{1}=3.3 \mathrm{k} \Omega, \mathrm{C}_{1}=39 \mathrm{pF}$ |  | 16 | - | $\mu \mathrm{S}$ |
| $\overline{\text { CS Wait Time }}$ | tcsw | - |  | 250 | - | ns |
| Data Processing Time | tooff | $\mathrm{R}_{1}=3.3 \mathrm{k} \Omega, \mathrm{C}_{1}=39 \mathrm{pF}$ |  | 8 | - | $\mu \mathrm{s}$ |
| RESET Pulse Width | twres | When $\overline{\text { RESET }}$ signal is input from microcontroller etc. externally |  | 250 | - | ns |
| $\overline{\text { RESET Time }}$ | $\mathrm{t}_{\text {RSON }}$ | When $\overline{\text { RESET }}$ signal is input from microcontroller etc. externally |  | 250 | - | ns |
|  |  | $\mathrm{R}_{2}=1.0 \mathrm{k} \Omega, \mathrm{C}_{2}=0.1 \mu \mathrm{~F}$ |  | - | 200 | $\mu \mathrm{S}$ |
| DA Wait Time | $t_{\text {RSOFF }}$ | - |  | 250 | - | ns |
| All Output Slew Rate | $t_{R}$ | $\mathrm{C}_{1}=100 \mathrm{pF}$ | $\mathrm{t}_{\mathrm{R}}=20$ to $80 \%$ | - | 2.0 | $\mu \mathrm{s}$ |
|  | $\mathrm{t}_{\mathrm{F}}$ |  | $\mathrm{t}_{\mathrm{F}}=80$ to 20\% | - | 2.0 | $\mu \mathrm{S}$ |
| $V_{\text {DD }}$ Rise Time | tprz | When mounted in the unit |  | - | 100 | $\mu \mathrm{s}$ |
| $V_{\text {DD }}$ Off Time | tpof | When mounted in the unit, $\mathrm{V}_{\mathrm{DD}}=0.0 \mathrm{~V}$ |  | 5.0 | - | ms |

## TIMING DIAGRAM

| Symbol | $\mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V} \pm 10 \%$ | $\mathrm{~V}_{\mathrm{DD}}=5.0 \mathrm{~V} \pm 10 \%$ |
| :---: | :---: | :---: |
| $\mathrm{~V}_{\mathrm{IH}}$ | $0.8 \mathrm{~V}_{\mathrm{DD}}$ | $0.7 \mathrm{~V}_{\mathrm{DD}}$ |
| $\mathrm{V}_{\mathrm{IL}}$ | $0.2 \mathrm{~V}_{\mathrm{DD}}$ | $0.3 \mathrm{~V}_{\mathrm{DD}}$ |

## - Data Timing



## - Reset Timing



## - Output Timing

All outputs


- Digit Output Timing (for 16-digit display, at a duty of 15/16)



## FUNCTIONAL DESCRIPTION

## Commands List



When data is written to RAM (DCRAM, CGRAM, ADRAM) continuously, addresses are internally incremented automatically.
Therefore it is not necessary to specify the 1st byte to write RAM data for the 2nd and later bytes.
Note: The test mode is used for inspection before shipment. It is not a user function.

## Positional Relationship Between SEGn and ADn (one digit)



## Data Transfer Method and Command Write Method

Display control command and data are written by an 8-bit serial transfer.
Write timing is shown in the figure below.
Setting the $\overline{\mathrm{CS}}$ pin to "Low" level enables a data transfer.
Data is 8 bits and is sequentially input into the DA pin from LSB (LSB first).
As shown in the figure below, data is read by the shift register at the rising edge of the shift clock, which is input into the $\overline{\mathrm{CP}}$ pin. If 8-bit data is input, internal load signals are automatically generated and data is written to each register and RAM.
Therefore it is not necessary to input load signals from the outside.
Setting the $\overline{\mathrm{CS}}$ pin to "High" disables data transfer. Data input from the point when the $\overline{\mathrm{CS}}$ pin changes from "High" to "Low" is recognized in 8-bit units.


* When data is written to RAM (DCRAM, ADRAM, CGRAM) continuously, addresses are internally incremented automatically.
Therefore it is not necessary to specify the 1st byte to write RAM data for the 2nd and later bytes.


## Reset Function

Reset is executed when the $\overline{\text { RESET }}$ pin is set to "L", (when turning power on, for example) and initializes all functions.
Initial status is as follows.

- Address of each RAM ............... address " 00 " H
- Data of each RAM ...................... All contents are undefined
- General output port .................... All general output ports go "Low"
- Display digit ............................. 16 digits
- Contrast adjustment ................... 8/16
- All display lights ON or OFF .... OFF mode
- Segment output …...................... All segment outputs go "Low"
- AD output .................................. All AD outputs go "Low"

Please set again according to "Setting Flowchart" after reset.

## Description of Commands and Functions

1. DCRAM data write
(Specifies the address of DCRAM and writes the character code of CGROM and CGRAM.)
DCRAM (Data Control RAM) has a 4-bit address to store character code of CGROM and CGRAM.
The character code specified by DCRAM is converted to a $5 \times 7$ dot matrix character pattern via CGROM or CGRAM.
(The DCRAM can store 16 characters.)
[Command format]

| 1st byte (1st) | LSB |  |  |  |  |  |  | MSB | selects DCRAM data write mode and specifies DCRAM address <br> (Ex: Specifies DCRAM address 0H) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | X0 | X1 | X2 | X3 | 1 | 0 | 0 | 0 |  |
|  | LSB |  |  |  |  |  |  | MSB |  |
|  | B0 | B1 | B2 | B3 | B4 | B5 | B6 | B7 | specifies character code of CGROM and CGRAM (written into DCRAM address 0 H ) |
| 2nd byte (2nd) | CO | C1 | C2 | C3 | C4 | C5 | C6 | C7 |  |

To specify the character code of CGROM and CGRAM continuously to the next address, specify only character code as follows.
The addresses of DCRAM are automatically incremented. Specification of an address is unnecessary.


X0 (LSB) to X3 (MSB) : DCRAM addresses (4 bits: 16 characters)
C0 (LSB) to C7 (MSB) : Character code of CGROM and CGRAM (8 bits: 256 characters)
[COM positions and set DCRAM addresses]

| HEX | X0 | X1 | X2 | X3 | COM <br> position |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | COM1 |
| 1 | 1 | 0 | 0 | 0 | COM2 |
| 2 | 0 | 1 | 0 | 0 | COM3 |
| 3 | 1 | 1 | 1 | 0 | COM4 |
| 4 | 0 | 0 | 1 | 0 | COM5 |
| 5 | 1 | 0 | 1 | 0 | COM6 |
| 6 | 0 | 1 | 1 | 0 | COM7 |
| 7 | 1 | 1 | 1 | 0 | COM8 |
| 8 | 0 | 0 | 0 | 1 | COM9 |
| 9 | 1 | 0 | 0 | 1 | COM10 |
| A | 0 | 1 | 0 | 1 | COM11 |
| B | 1 | 1 | 0 | 1 | COM12 |
| C | 0 | 0 | 1 | 1 | COM13 |
| D | 1 | 0 | 1 | 1 | COM14 |
| E | 0 | 1 | 1 | 1 | COM15 |
| F | 1 | 1 | 1 | 1 | COM16 |

2. CGRAM data write
(Specifies the addresses of CGRAM and writes character pattern data.)
CGRAM (Character Generator RAM) has a 3-bit address to store $5 \times 7$ dot matrix character patterns.
A character pattern stored in CGRAM can be displayed by specifying the character code (address) by DCRAM.
The address of CGRAM is assigned to 00 H to 07 H . (All the other addresses are the CGROM addresses.) (The CGRAM can store 8 types of character patterns.)
[Command format]


To specify character pattern data continuously to the next address, specify only character pattern data as follows.
The addresses of CGRAM are automatically incremented. Specification of an address is therefore unnecessary.
The 2 nd to 6 th byte (character pattern data) are regarded as one data item, so 250 ns is sufficient for $\mathrm{t}_{\text {DOFF }}$ time between bytes.

specifies 1 st column data
(rewritten into CGRAM address 01 H )
specifies 5th column data
(rewritten into CGRAM address 01 H )

X0 (LSB) to X2 (MSB) : CGRAM addresses (3 bits: 8 characters)
C0 (LSB) to C34 (MSB) : Character pattern data ( 35 bits: 35 outputs per digit)

* : Don't care
[CGROM addresses and set CGRAM addresses]
Refer to ROMCODE table

| HEX | X0 | X1 | X2 | CGROM address |
| :---: | :---: | :---: | :---: | :---: |
| 00 | 0 | 0 | 0 | RAM00(00000000B) |
| 01 | 1 | 0 | 0 | RAM01(00000001B) |
| 02 | 0 | 1 | 0 | RAM02(00000010B) |
| 03 | 1 | 1 | 0 | RAM03(00000011B) |
| 04 | 0 | 0 | 1 | RAM04(00000100B) |
| 05 | 1 | 0 | 1 | RAM05(00000101B) |
| 06 | 0 | 1 | 1 | RAM06(00000110B) |
| 07 | 1 | 1 | 1 | RAM07(00000111B) |

Positional relationship between the output area of CGROM and that of CGRAM


Note: CGROM (Character Generator ROM) has an 8 -bit address to generate $5 \times 7$ dot matrix character patterns. CGRAM can store 248 types of character patterns.
3. ADRAM data write
(specifies address of ADRAM and writes symbol data)
ADRAM (Additional Data RAM) has a 2-bit address to store symbol data.
Symbol data specified by ADRAM is directly output without CGROM and CGRAM.
(The ADRAM can store 2 types of symbol patterns for each digit.)
The terminal to which the contents of ADRAM are output can be used as a cursor.
[Command format]

| 1st byte (1st) | LSB B0 |  |  |  |  |  |  | $\begin{gathered} \text { MSB } \\ \text { B7 } \end{gathered}$ | selects ADRAM data write mode and specifies ADRAM address <br> (Ex: specifies ADRAM address OH) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | X0 | X1 | X2 | X3 | 1 | 1 | 0 | 0 |  |
|  | LSB |  |  |  |  |  |  | MSB |  |
|  | B0 | B1 | B2 | B3 | B4 | B5 | B6 | B7 |  |
| 2nd byte (2nd) | C0 | C1 | * | * | * | * | * | * | sets symbol data <br> (written into ADRAM address 0 H ) |

To specify symbol data continuously to the next address, specify only symbol data as follows.
The address of ADRAM is automatically incremented. Specification of addresses is therefore unnecessary.


$$
\begin{array}{ll}
\text { X0 (LSB) to X3 (MSB) } & \text { : ADRAM addresses (4 bits: } 16 \text { characters) } \\
\text { C0 (LSB) to C1 (MSB) } & \text { : Symbol data (2 bits: 2-symbol data per digit) } \\
& \text { *: Don't care }
\end{array}
$$

[COM positions and ADRAM addresses]

| HEX | X0 | X1 | X2 | X3 | COM position |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | COM1 |
| 1 | 1 | 0 | 0 | 0 | COM2 |
| 2 | 0 | 1 | 0 | 0 | COM3 |
| 3 | 1 | 1 | 1 | 0 | COM4 |
| 4 | 0 | 0 | 1 | 0 | COM5 |
| 5 | 1 | 0 | 1 | 0 | COM6 |
| 6 | 0 | 1 | 1 | 0 | COM7 |
| 7 | 1 | 1 | 1 | 0 | COM8 |
| 8 | 0 | 0 | 0 | 1 | COM9 |
| 9 | 1 | 0 | 0 | 1 | COM10 |
| A | 0 | 1 | 0 | 1 | COM11 |
| B | 1 | 1 | 0 | 1 | COM12 |
| C | 0 | 0 | 1 | 1 | COM13 |
| D | 1 | 0 | 1 | 1 | COM14 |
| E | 0 | 1 | 1 | 1 | COM15 |
| F | 1 | 1 | 1 | 1 | COM16 |

4. General output port set
(specifies the general output port status)
The general output port is an output for 2-bit static operation.
It is used to control other I/O devices and turn on LED. (static operation)
When at the "High" level, this output becomes the VDD voltage, and when at the "Low" level, it becomes the ground potential. Therefore, the fluorescent display tube cannot be driven.
[Command format]


P1, P2 : general output port

* : don't care
[Set data and set state of general output port]

| P1 | P2 | Display state of general output port |
| :---: | :---: | :--- |
| 0 | 0 | Sets P1 and P2 to low |
| 1 | 0 | Sets P1 to high and P2 to low |
| 0 | 1 | Sets P1 to low and P2 to high |
| 1 | 1 | Sets P1 and P2 to high | $\leftarrow$ (The state when power is applied or when $\overline{\text { RESET }}$ is input.)

5. Display duty set
(writes display duty value to duty cycle register)
Display duty adjusts contrast in 8 stages using 3-bit data.
When power is turned on or when the RESET signal is input, the duty cycle register value is " 0 ". Always execute this instruction before turning the display on, then set a desired duty value.
[Command format]


D0 (LSB) to D2 (MSB) : display duty data (3 bits: 8 stages)

* : don't care
[Relation between setup data and controlled COM duty]

| HEX | D0 | D1 | D2 | COM duty |
| :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | $8 / 16$ |
| 1 | 1 | 0 | 0 | $9 / 16$ |
| 2 | 0 | 1 | 0 | $10 / 16$ |
| 3 | 1 | 1 | 0 | $11 / 16$ |
| 4 | 0 | 0 | 1 | $12 / 16$ |
| 5 | 1 | 0 | 1 | $13 / 16$ |
| 6 | 0 | 1 | 1 | $14 / 16$ |
| 7 | 1 | 1 | 1 | $15 / 16$ |

$\leftarrow$ (The state when power is turned on or when $\overline{\text { RESET }}$ signal is input.)
6. Number of digits set
(writes the number of display digits to the display digit register)
The number of digits set can display 9 to 16 digits using 3-bit data.
When power is turned on or when a $\overline{\text { RESET }}$ signal is input, the number of digit register value is " 0 ". Always execute this instruction to change the number of digits before turning the dispaly on.

## [Command format]


: selects the number of digit set mode and specifies the number of digit value

K0 (LSB) to K2 (MSB) : number of digit data (3 bits: 8 digits)

* : don't care
[Relation between setup data and controlled COM]

| HEX | K0 | K1 | K2 | Number of digits of <br> COM |
| :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | COM1 to 16 |
| 1 | 1 | 0 | 0 | COM1 to 9 |
| 2 | 0 | 1 | 0 | COM1 to 10 |
| 3 | 1 | 1 | 0 | COM1 to 11 |
| 4 | 0 | 0 | 1 | COM1 to 12 |
| 5 | 1 | 0 | 1 | COM1 to 13 |
| 6 | 0 | 1 | 1 | COM1 to 14 |
| 7 | 1 | 1 | 1 | COM1 to 15 |

$\leftarrow$ (The state when power is turned on or when $\overline{\text { RESET }}$ signal is input.)
7. All display lights ON/OFF set
(turns all dispaly lights ON or OFF)
All display lights ON is used primarily for display testing.
All display lights OFF is primarily used for display blink and to prevent malfunction when power is turned on.
This command cannot control the general output port.
[Command format]
 : selects all display lights ON or OFF mode

L: sets all lights OFF
H : sets all lights ON
*: Don't care
[Set data and display state of SEG and AD]

| L | H | Display state of SEG and AD |
| :---: | :---: | :--- |
| 0 | 0 | Normal display |
| 1 | 0 | Sets all outputs to Low |
| 0 | 1 | Sets all outputs to High |
| 1 | 1 | Sets all outputs to High | $\leftarrow$ (The state when power is applied or when $\overline{\text { RESET }}$ is input.) $\leftarrow$ (All lights ON mode has priority.)

## Setting Flowchart

(Power applying included)


## Power-off Flowchart



## APPLICATION CIRCUIT



Notes: 1. The $\mathrm{V}_{\mathrm{DD}}$ value depends on the power supply voltage of the microcontroller used. Adjust the values of the constants $\mathrm{R}_{1}, \mathrm{R}_{2}, \mathrm{R}_{4}, \mathrm{C}_{1}$, and $\mathrm{C}_{2}$ to the power supply voltage used.
2. The $\mathrm{V}_{\mathrm{FL}}$ value depends on the fluorescent display tube used. Adjust the values of the constants $\mathrm{R}_{3}$ and ZD to the power supply voltage used.

## Reference data

The figure below shows the relationship between the $\mathrm{V}_{\mathrm{FL}}$ voltage and the output current of each driver. Take care that the total power consumption to be used does not exceed the power dissipation.


## ML9208－01 ROM CODE

＊ROM CODE＿A is the character set for SEGA1 to SEGA35．
＊00000000b（00h）to $00001111 \mathrm{~b}(0 \mathrm{Fh})$ are the CGRAM＿A addresses．

|  | 0000 | 0001 | 0010 | 0011 | 0100 | 0101 | 0110 | 0111 | 1000 | 1001 | 1010 | 1011 | 1100 | 1101 | 1110 | 1111 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0000 | RAM0 | サH |  |  |  |  |  |  |  |  | $\#$ <br> $\# \#$ |  |  |  |  |  |
| 0001 | RAM1 |  |  |  |  |  | \＃\＃ $\# \#$ $\# \#$ |  |  |  |  | $\square$ $\square$ $\square$ |  |  |  |  |
| 0010 | RAM2 |  |  |  | $\begin{aligned} & \text { \# } \\ & \square \\ & \square \end{aligned}$ |  |  |  |  |  |  |  |  |  |  |  |
| 0011 | RAM3 |  |  |  |  |  |  |  |  |  |  | 世 |  |  | H2 |  |
| 0100 | RAM4 |  |  |  |  |  | $\Psi B$ $\Psi B$ |  |  |  |  |  $\square$ <br>  $\square$ <br>  $H$ |  1 <br>  4 <br>  $\square$ |  |  |  |
| 0101 | RAM5 |  | \＃ |  |  | $\square$ <br>  <br>  | \＃ |  |  |  |  | \＃$\quad \rightarrow$ |  |  |  |  |
| 0110 | RAM6 |  |  |  |  |  |  |  |  | Bran |  | 泪 | $\square$ <br> $\square$ |  |  |  |
| 0111 | RAM7 | $\square$ |  |  |  |  |  |  |  |  |  $\square$ <br>  $\square$ <br>  $\square$ |  |  | $\square$ $\square$ $\square$ |  |  |
| 1000 | 民\＃ |  | $\square$ $\square$ $\square$ $\square$ |  |  |  |  |  |  |  |  |  |  |  |  |  |
| 1001 |  |  |  |  |  |  | $\square$ |  | $\square$ $\#$ $\square$ $\square$ |  | $\square$ |  |  | $\square$ $\# B$ $\#$ |  |  |
| 1010 |  |  |  |  |  |  | \＃\＃ |  | $\square$ |  | PR |  |  |  |  |  |
| 1011 |  |  |  | $\square$ |  |  | $\square$ $\square$ $\square$ |  |  |  |  |  |  |  | （10 |  |
| 1100 |  |  |  |  | $\square$ $\square$ $H$ |  | EA |  |  |  |  | Pan | Han | $\square=$ <br> $\square$ <br> $\square$ <br> $\square$ |  | $\square$ <br> $\square$ <br>  |
| 1101 |  | \＃\＃ | \＃\＃ | $\square$ |  |  |  |  |  |  | $\square$ <br> $\square$ |  | \＃\＃ |  |  |  |
| 1110 |  |  |  |  |  |  | $\square$ $\square$ $\square$ |  | \＃$\quad 7$ |  |  | 1 1 <br> 7 8 | \＃\＃ |  |  |  |
| 1111 | HA |  |  |  |  |  |  |  |  |  |  | HA |  | \＃n |  |  |

## PACKAGE DIMENSIONS

(Unit: mm)


Notes for Mounting the Surface Mount Type Package
The surface mount type packages are very susceptible to heat in reflow mounting and humidity absorbed in storage. Therefore, before you perform reflow mounting, contact Oki's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).
(Unit: mm)


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## REVISION HISTORY

| Document <br> No. | Date | Page |  | Description |
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